

JOC817X1 Series

Rev.A.1.2

DESCRIPTION:

The JOC817X1 photocoupler consist of an infrared light-emitting diode and a phototransistor. The devices can realize electrical isolation and signal transmission between different circuits. The products are widely used in power supply equipment, such as mobile phone charger, home appliance product power supply device, etc.

MAIN FEATURES

Current transfer ratio (CTR: 80%-600% @ $I_F=5mA$, $V_{CE}=5V$)

High isolation voltage between input and output

($V_{iso}=5,000V_{rms}$)

Creepage distance > 7.62mm

Operating temperature up to +110°C

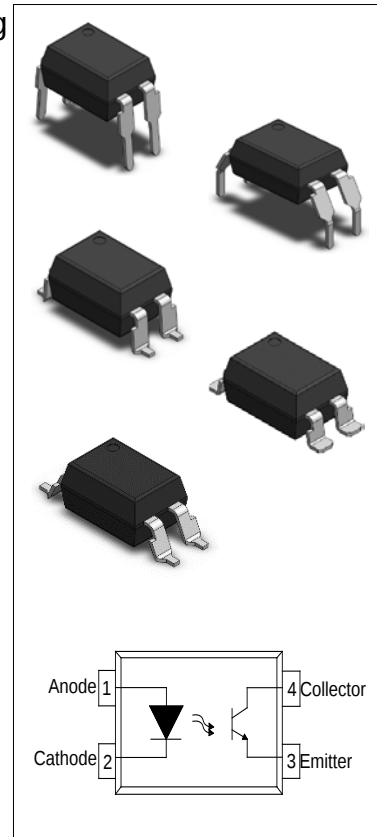
Collector-Emitter voltage $BV_{CEO} \geq 35V$

CQC approved

VDE approved

UL approved

The products comply with RoHS, REACH and HF



ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

Parameter		Symbol	Value	Unit
Input	Forward Current	I_F	60	mA
	Peak Forward Current	I_{FP}	1 ^①	A
	Reverse Voltage	V_R	6	V
	Power Dissipation	P_D	100	mW
Output	Collector-emitter Voltage	V_{CEO}	35	V
	Emitter-collector Voltage	V_{ECO}	6	V
	Collector Current	I_C	50	mA
	Power Dissipation	P_C	150	mW
Total Power Dissipation		P_{tot}	200	mW
Isolation Voltage		V_{iso}	5000 ^②	Vrms
Operating Temperature		T_{opr}	-55~+110	°C
Storage Temperature		T_{stg}	-55~+125	°C

Soldering Temperature	T_{sol}	260	°C
-----------------------	-----------	-----	----

NOTE1: 100us pulse, 100Hz frequency

NOTE2: AC for 1minute, R.H.=40~60%

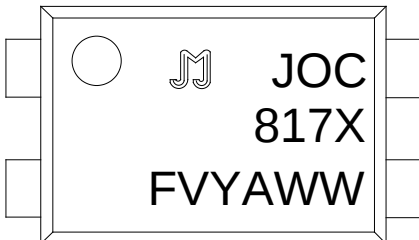
ELECTRICAL CHARACTERISTICS (Temperature=25°C)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V_F	$I_F=10mA$	-	1.2	1.3	V
			$I_F=20mA$	-	1.24	1.4	
	Reverse Current	I_R	$V_R=6V$	-	-	1	μA
	Terminal Capacitance	C_t	$V=0, f=1kHz$	-	30	250	pF
Output	Collector-Emitter dark current	I_{CEO}	$V_{CE}=20V, I_F=0$	-	-	50	nA
	Collector-Emitter breakdown voltage	BV_{CEO}	$I_C=0.1mA, I_F=0$	35	-	-	V
	Emitter-Collector breakdown voltage	BV_{ECO}	$I_E=0.1mA, I_F=0$	6	-	-	V
Transfer Characteristics	Current transfer ratio	$CTR^{①}$	$I_F=5mA, V_{CE}=5V$	80	-	600	%
	Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_F=20mA, I_C=1mA$	-	0.06	0.2	V
	Isolation resistance	R_{IO}	DC500V 40~60%R.H.	5×10^{10}	10^{11}	-	Ω
	Floating Capacitance	C_{IO}	$V=0, f=1MHz$	-	0.4	1	pF
	Cut-off Frequency	f_c	$V_{CE}=5V, I_C=2mA, R_L=100\Omega, -3dB$	-	80	-	kHz
	Rise Time	t_r	$V_{CE}=2V, I_C=2mA, R_L=100\Omega$	-	5	18	μs
	Fall Time	t_f		-	4	18	μs
	Response Time	t_{on}		-	9	25	μs
		t_{off}		-	5	25	μs

NOTE1: Rank Table of Current Transfer Ratio (Temperature=25°C)

Grade Sign	Min. (%)	Max. (%)
A	80	160
B	130	260
C	200	400
D	300	600
E	100	200
F	150	300

ORDERING AND MARKING INFORMATION

MARKING INFORMATION			
		JOC : Company Abbr. 817 : Part Number X : CTR Rank F : Leadframe Option V : VDE Option Y : Fiscal Year A : Manufacturing Code WW : Work Week	
ORDERING INFORMATION			
JOC817X1(Y)(Z)-FGV			
JOC – Company Abbr. 817 – Part Number X1 – Rank (A1/B1/C1/D1) Y – Lead Form Option (M/S/SL/SLM/None) Z – Tape and Reel Option (T1/T2/T3/T4) F – Leadframe Option (F:Iron, None:Copper) G – Green V – VDE Option (V or None)			
Packing Quantity			
Option	Quantity	Quantity – Inner box	Quantity –Outer box
None/M	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box =32k Units
S(T1/T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box =22.5k Units
S(T3)/S(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box =15k Units
SL(T1/T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box =22.5k Units
SL(T3)/SL(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box =15k Units
SLM(T1/T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box =22.5k Units

Characteristics Curves

FIG.1: Forward Current vs. Ambient Temperature

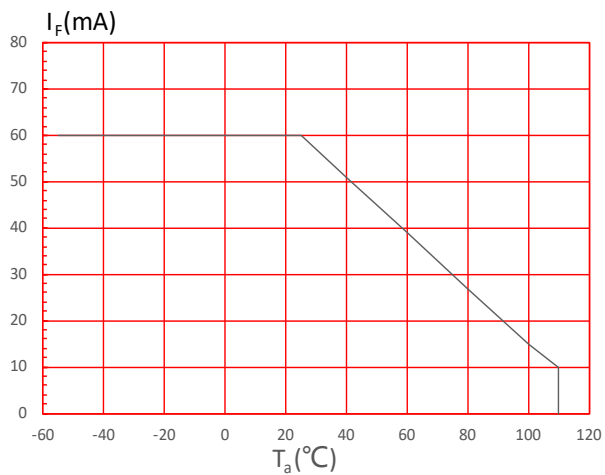


FIG.2: Collector Power Dissipation vs. Ambient Temperature

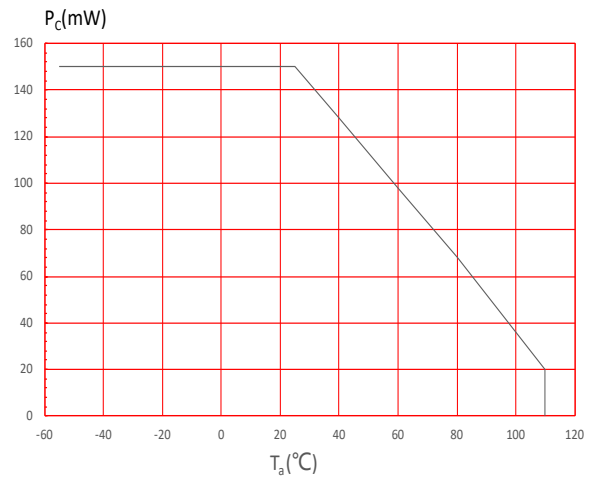


FIG.3: Forward Current vs. Forward Voltage

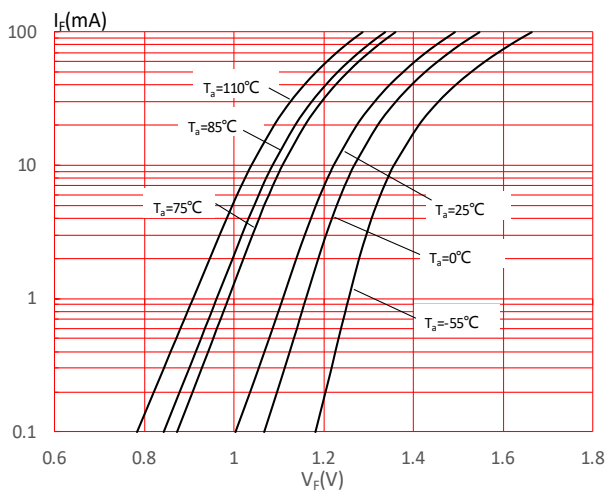


FIG.4: Collector Dark Current vs. Ambient Temperature

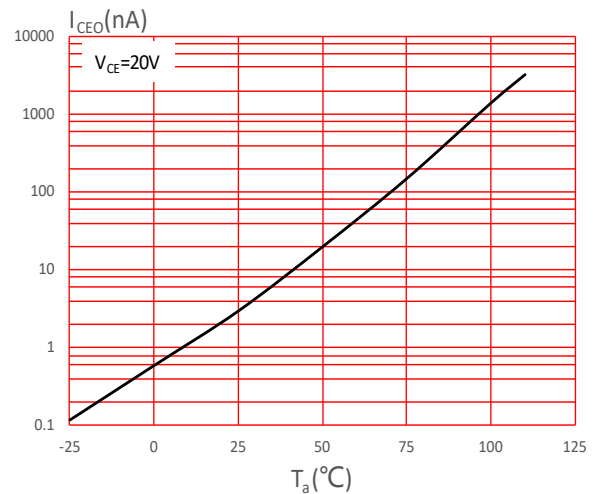


FIG.5: Collector Current vs. Collector-emitter Voltage

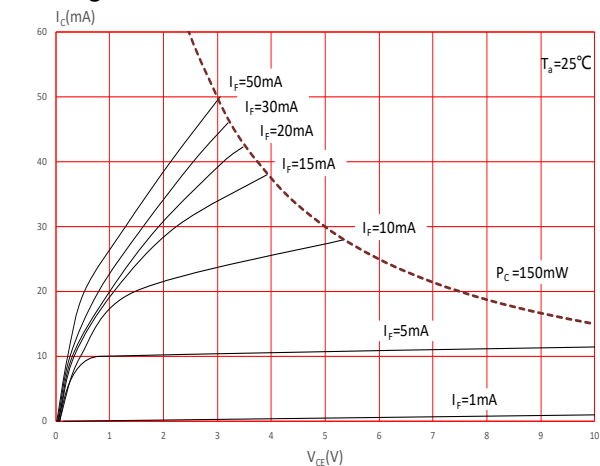


FIG.6: Current Transfer Ratio vs. Forward Current

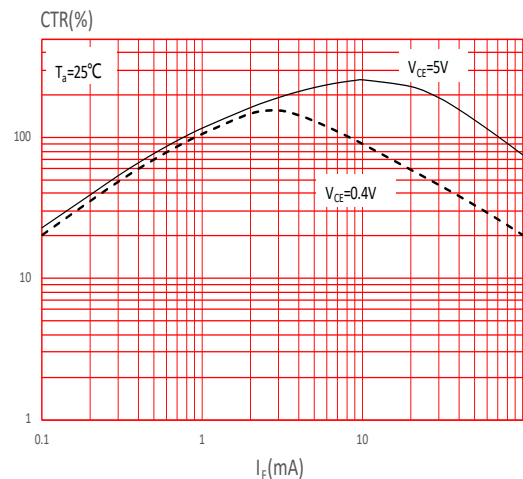


FIG.7: Normalized Current Transfer Ratio vs. Ambient Temperature

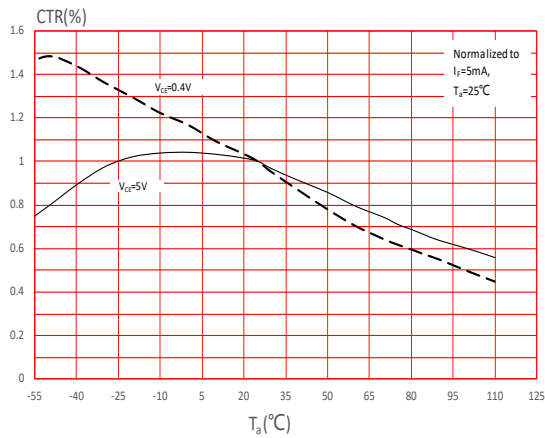


FIG.8: Collector-emitter Saturation Voltage vs. Ambient Temperature

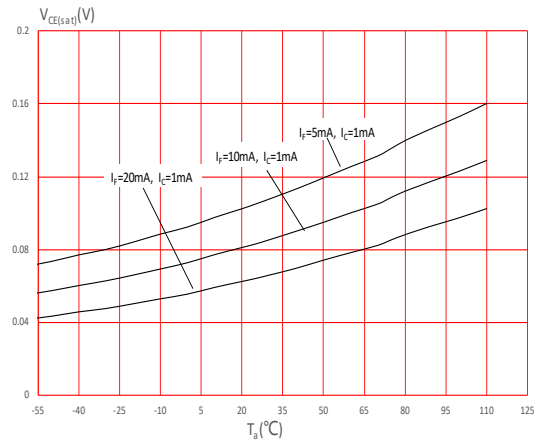


FIG.9: Response Time vs. Load Resistance

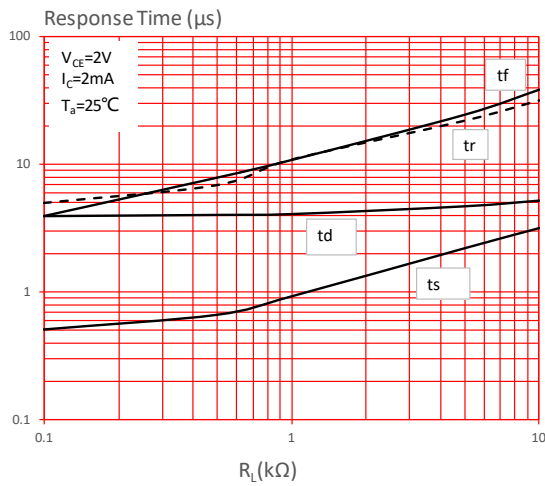
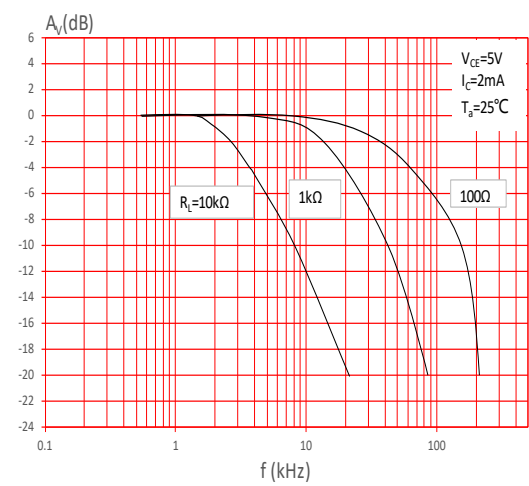
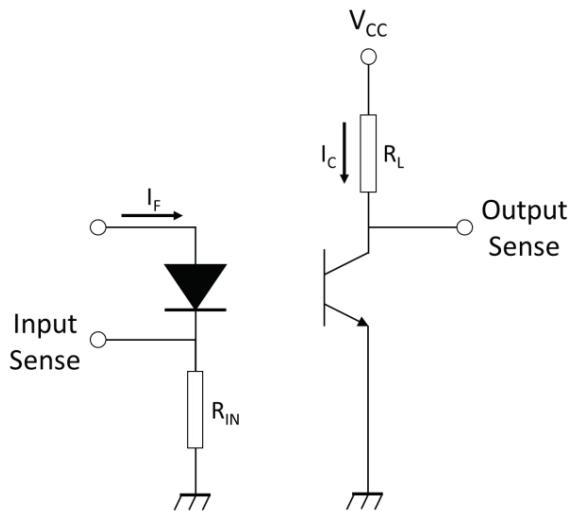
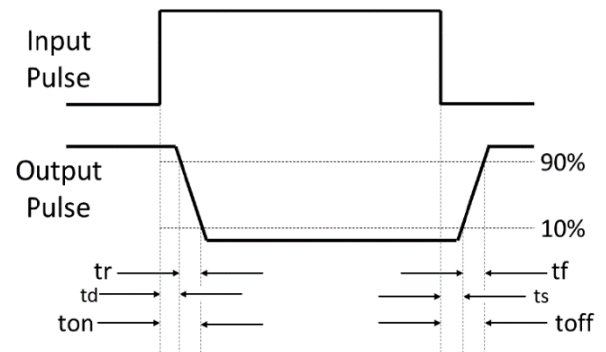
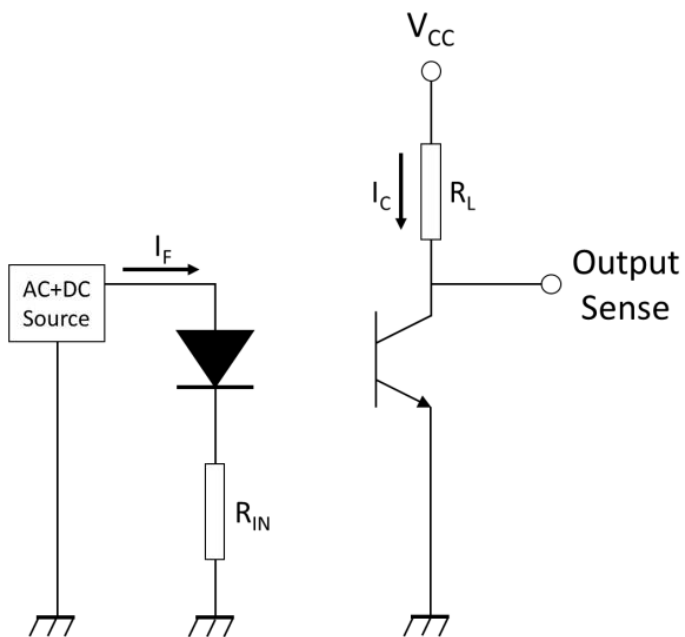


FIG.10: Frequency Response

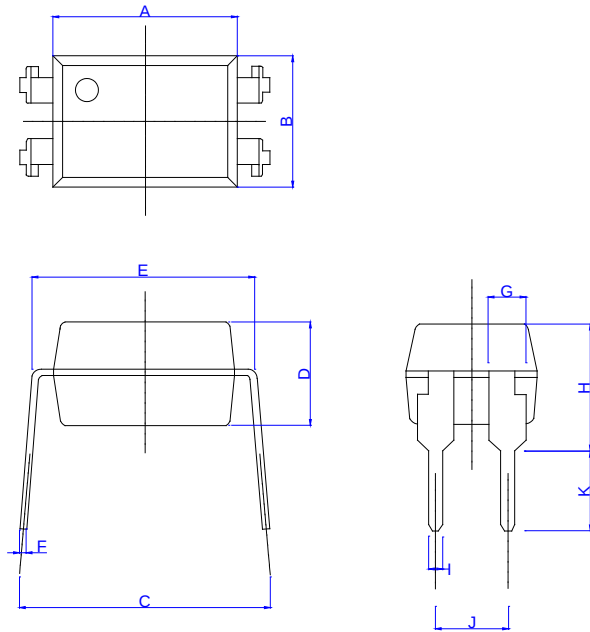


Test Circuits

FIG.11: Test Circuits of Response Time

FIG.12: Curves of Response Time

FIG.13: Test Circuits of Frequency Response


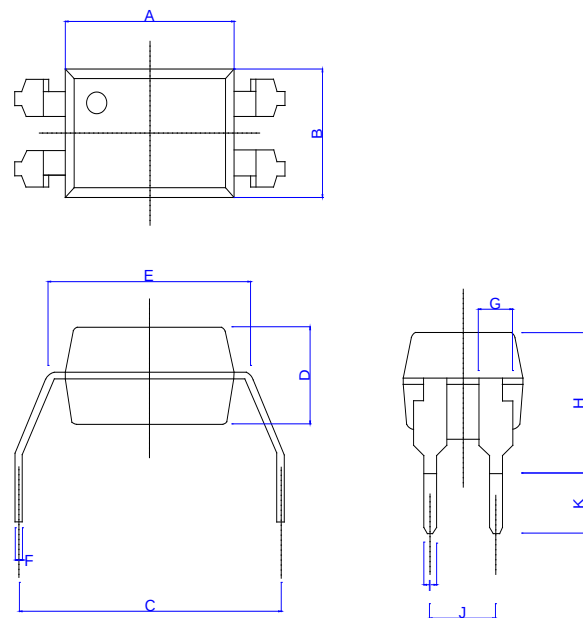
Package Dimension (Unit: mm)

Standard DIP Type:



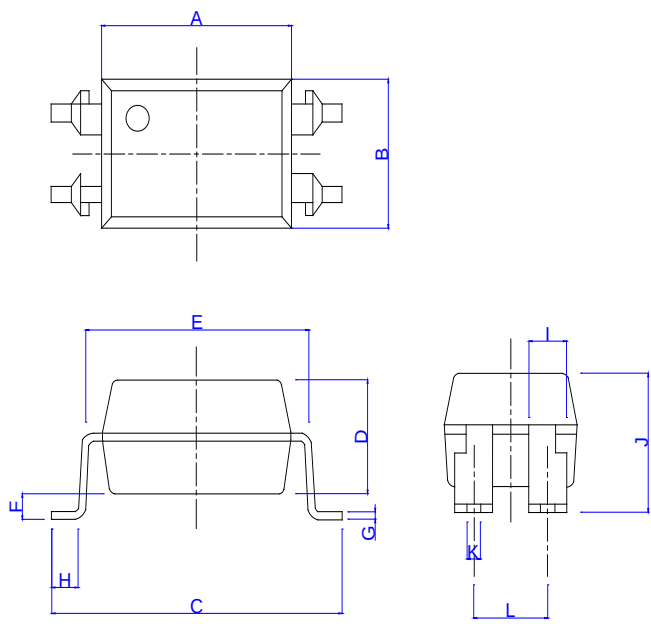
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	6.20		6.80	0.245		0.269
B	4.30		4.90	0.170		0.194
C	7.62		9.50	0.301		0.375
D	3.20		3.80	0.126		0.150
E	7.37		7.87	0.291		0.311
F		0.25			0.010	
G	1.10		1.50	0.043		0.059
H	4.20		4.80	0.166		0.190
I		0.50			0.020	
J		2.54			0.100	
K		2.80			0.111	

Option M Type:



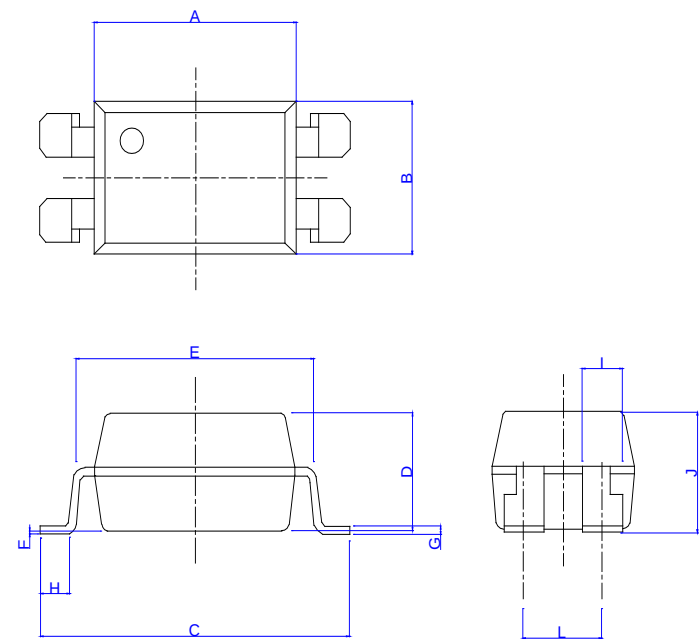
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	6.20		6.80	0.245		0.269
B	4.30		4.90	0.170		0.194
C	9.90		10.50	0.391		0.415
D	3.20		3.80	0.126		0.150
E	7.37		7.87	0.291		0.311
F		0.25			0.010	
G	1.10		1.50	0.043		0.059
H	4.28		4.88	0.169		0.193
I		0.50			0.020	
J		2.54			0.100	
K		2.20			0.087	

Option S Type:



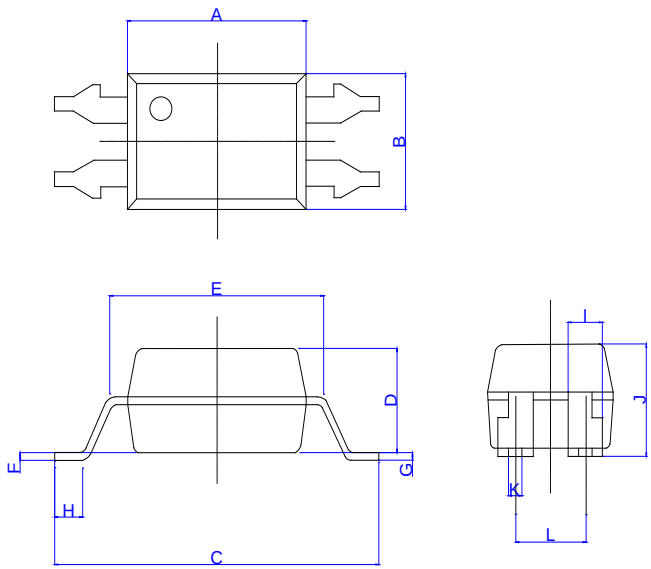
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	6.20		6.80	0.245		0.269
B	4.30		4.90	0.170		0.194
C	9.90		10.50	0.391		0.415
D	3.30		3.70	0.130		0.146
E	7.32		7.92	0.289		0.313
F		0.80			0.032	
G		0.25			0.010	
H		0.80			0.032	
I	1.20		1.40	0.047		0.055
J	4.00		4.60	0.158		0.182
K		0.50			0.020	
L		2.54			0.100	

Option SL Type:



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	6.20		6.80	0.245		0.269
B	4.30		4.90	0.170		0.194
C	9.90		10.50	0.391		0.415
D	3.30		3.70	0.130		0.146
E	7.32		7.92	0.289		0.313
F		0.10			0.004	
G		0.25			0.010	
H	0.50		1.10	0.020		0.043
I	1.20		1.40	0.047		0.055
J	4.00		4.60	0.158		0.182
L		2.54			0.100	

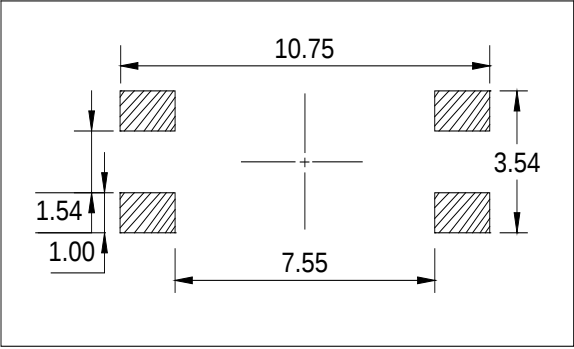
Option SLM Type:



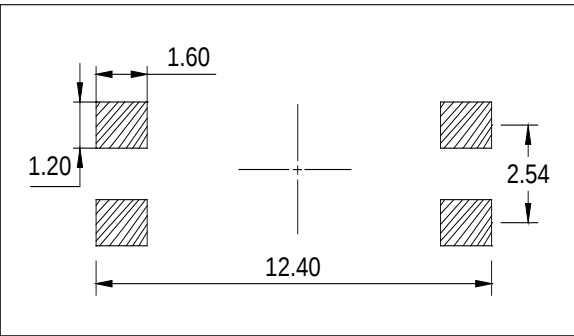
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	6.30		6.70	0.249		0.265
B	4.38		4.78	0.173		0.189
C	11.60		12.10	0.458		0.478
D	3.30		3.70	0.130		0.146
E	7.32		7.92	0.289		0.313
F	0.00		0.30	0.000		0.012
G	0.20		0.30	0.008		0.012
H	0.50		0.90	0.020		0.036
I	1.15		1.35	0.045		0.053
J	3.45		3.85	0.136		0.152
K	0.45		0.55	0.018		0.022
L	2.34		2.74	0.092		0.108

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

Option S/SL:

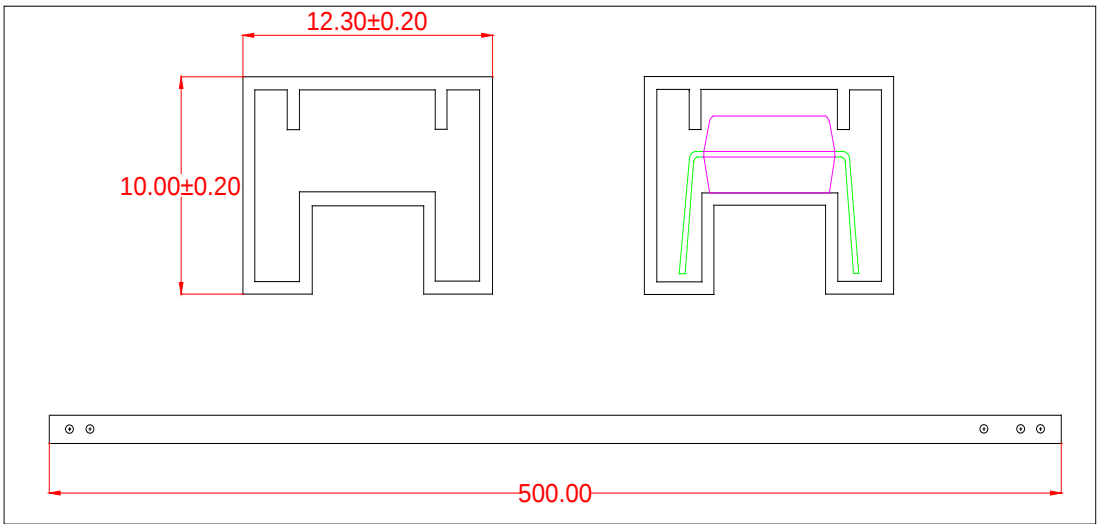


Option SLM:



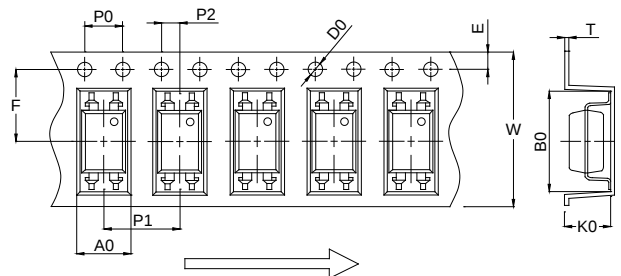
TUBE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Standard DIP/M

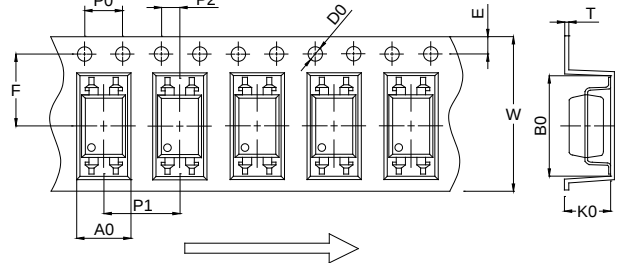


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T1) & SL(T1)

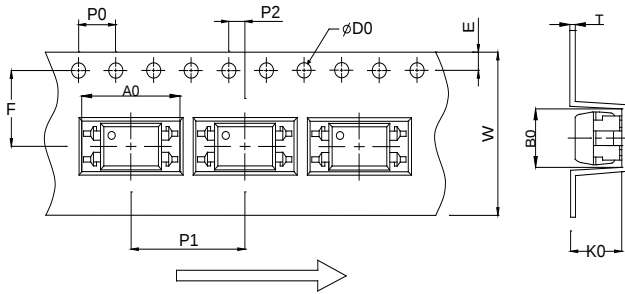


Option S(T2) & SL(T2)

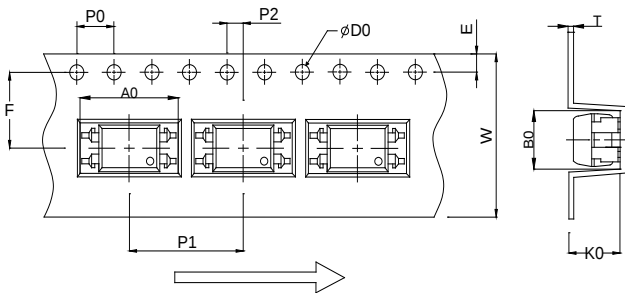


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A0	4.80		5.10	0.190		0.202
B0	10.30		10.65	0.407		0.421
D0	1.40	1.50	1.60	0.055	0.059	0.063
K0	4.00		4.30	0.158		0.170
P0	3.90	4.00	4.10	0.154	0.157	0.162
P1	7.90	8.00	8.10	0.312	0.315	0.320
P2	1.90	2.00	2.10	0.075	0.079	0.083
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.292	0.295	0.300
T	0.30	0.40	0.50	0.012	0.016	0.020
W	15.70	16.00	16.30	0.621	0.630	0.644

Option S(T3) & SL(T3)

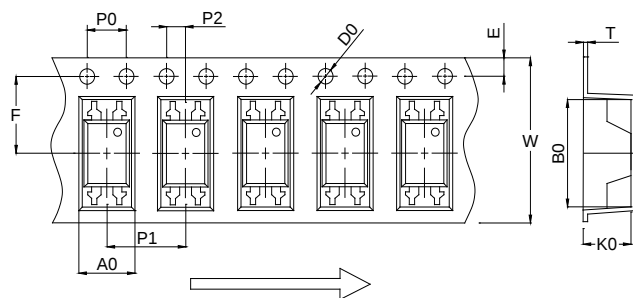


Option S(T4) & SL(T4)

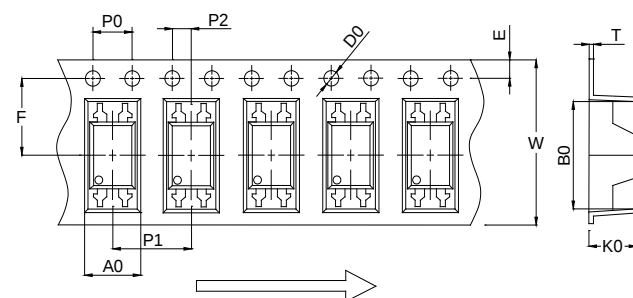


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A0	10.60	10.70	10.80	0.417	0.421	0.425
B0	4.80	4.90	5.00	0.189	0.193	0.197
D0	1.40	1.50	1.60	0.055	0.059	0.063
K0	4.10	4.20	4.30	0.161	0.165	0.170
P0	3.90	4.00	4.10	0.154	0.157	0.162
P1	11.9	12.0	12.1	0.469	0.472	0.476
P2	1.90	2.00	2.10	0.075	0.079	0.083
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.292	0.295	0.300
T	0.37	0.40	0.43	0.015	0.016	0.017
W	15.80	16.00	16.20	0.622	0.630	0.638

Option SLM(T1)



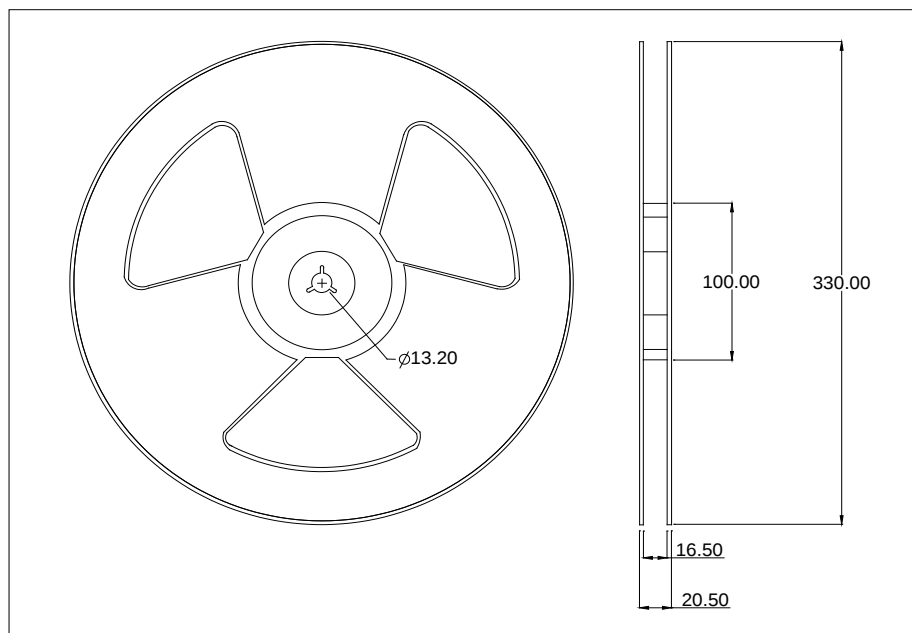
Option SLM(T2)



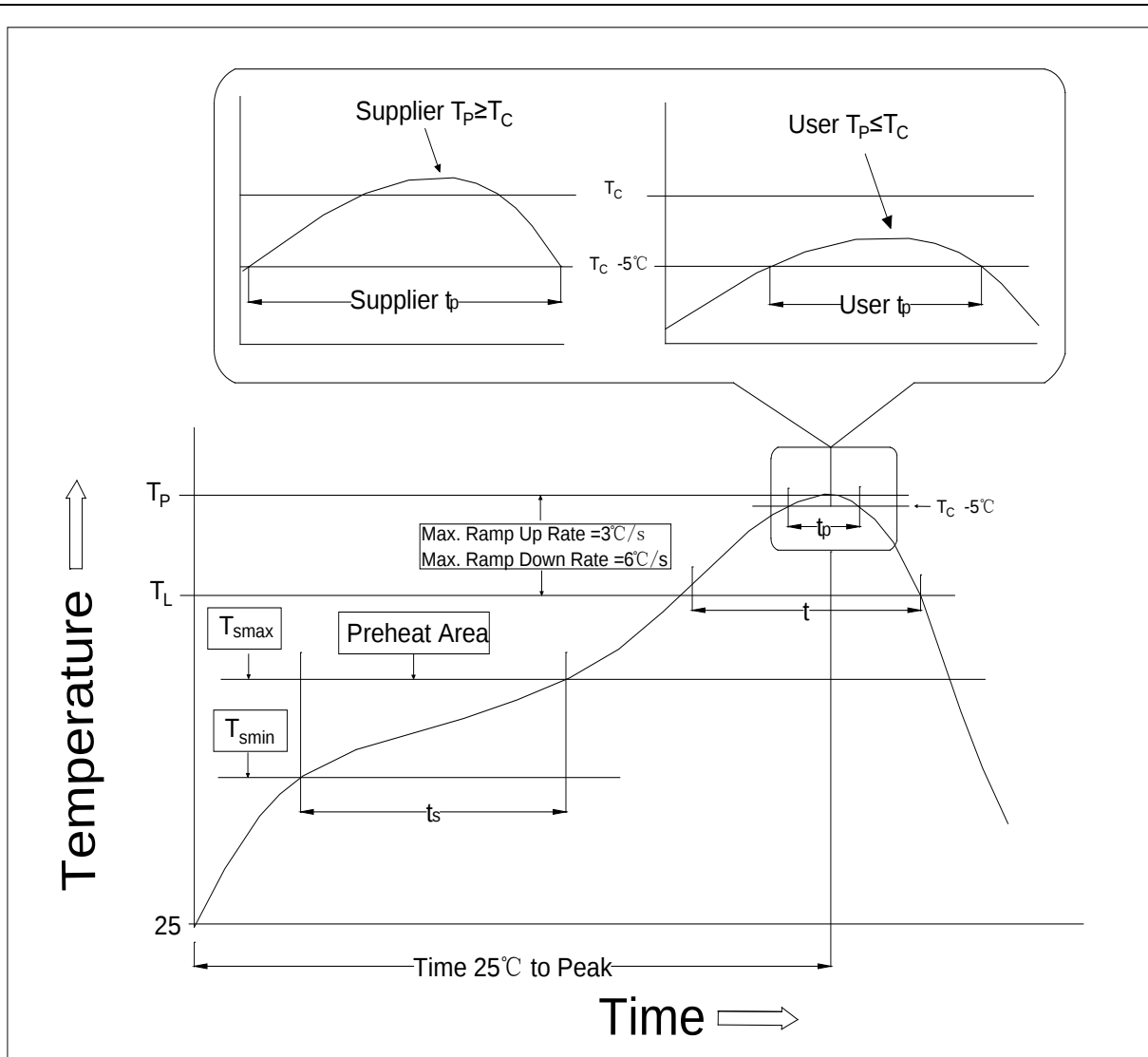
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A0	4.60		4.80	0.182		0.190
B0	12.20		12.40	0.482		0.490
D0	1.40		1.60	0.055		0.063
K0	4.10		4.30	0.162		0.170
P0	3.90		4.10	0.154		0.162
P1	7.90		8.10	0.312		0.320
P2	1.90		2.10	0.075		0.083
E	1.65		1.85	0.065		0.073
F	11.45		11.55	0.453		0.457
T	0.35		0.45	0.014		0.018
W	23.70		24.30	0.937		0.960

REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S & SL & SLM



REFLOW INFORMATION



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	100	150°C
Temperature Max. (T_{smax})	150	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t_L to t_P)	3°C/second max.	3°C/second max.
Liquidus Temperature (T_L)	183°C	217°C
Time (t_L) Maintained Above (T_L)	60-150 seconds	60-150 seconds
Peak Body Package Temperature	235°C+0°C/-5°C	260°C+0°C/-5°C
Time (t_P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Information furnished in this document is believed to be accurate and reliable. However, Jiangsu JieJie Microelectronics Co., Ltd. assumes no responsibility for the consequences of use without consideration for such information nor use beyond it. Information mentioned in this document is subject to change without notice, apart from that when an agreement is signed, Jiangsu JieJie complies with the agreement.

Products and information provided in this document have no infringement of patents. Jiangsu JieJie assumes no responsibility for any infringement of other rights of third parties which may result from the use of such products and information. This document supersedes and replaces all information previously supplied.

 is a registered trademark of Jiangsu JieJie Microelectronics Co., Ltd.

Copyright © 2025 Jiangsu JieJie Microelectronics Co., Ltd. All rights reserved.